





Wenn's ums Löten geht When it's about soldering Quand il s'agit du soudage

Technical Data Sheet

STANNOL® Solder FLOWTIN® TC

New Lead-Free Solder Alloy for Electronic Application

- > Eutectic Solder (melting point at 227°C)
- > Good wetting behaviour
- Fine grain and smooth surface better than **ECOLOY**® **TC** (S-Sn99Cu1)
- > Reduced dissolution of substrate metal compared with ECOLOY® TC (S-Sn99Cu1)
- > Easy disposal no lead containing waste.

Description

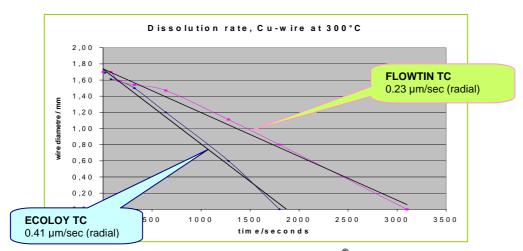
STANNOL® FLOWTIN® TC solders have been designed to eliminate the use of lead containing solders in electric and electronics manufacturing.

Application

Like with **ECOLOY**® **TC** solder it is necessary to adjust machine settings, temperature profiles, and other parameters to the requirements of a lead free process. But there is nothing to do when switching from **ECOLOY**® **TC** to **FLOWTIN**® **TC**, all settings and parameters remain the same. The properties of the solder joints are at least comparable or even better than tin/lead.

The physical properties of **FLOWTIN**[®] **TC** do not change compared to common tin/copper solder. But there are differences between **ECOLOY**[®] **TC** and **FLOWTIN**[®] **TC** with micro additives.

- The solder joint solidifies as fine grain metal; therefore the surface is shinier
- The dissolution of substrate metal is reduced
- The service life of solder baths is extended due to smaller copper enrichment



Radial dissolution of copper wire in FLOWTIN® TC solder bath @300°C

The above values are typical and represent no form of specification. The Data Sheet serves for information purposes. Any verbal or written advise is not binding for the company, whether such information originates from the company offices or from a sales representative. This is also in respect of any protection rights of third parties, and does not release the customer from the responsibility of verifying the products of the company for suitability of use for the intended process or purpose. Should any liability on the part of the company arise, the company will only indemnify for loss or damage to the same extent as for defects in quality.

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STANNOL GmbH







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Physical and Mechanical Properties of ECOLOY® and FLOWTIN® solders compared with Sn63Pb37:

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		STANNOL [®]	STANNOL [®]	STANNOL [®]	STANNOL [®]
Properties	S-Sn63Pb37*	ECOLOY TSC	ECOLOY® TS	ECOLOY® TC	FLOWTIN® TC
	C Circor Sor	(S-Sn95Ag4Cu1)*	(S-Sn96Ag4)*	(S-Sn99Cu1)*	(S-Sn99Cu1)**
		` '			
Melting Point, °C	183	217	221	227	227
g : c, c					
Electrical Conductivity %IACS	11.9	13	14	15.6	-
Electrical	14.5	13	12.3	12.6	-
Resistivity, μΩcm					
Drinell Hardness HD	17	15	15	9	-
Brinell Hardness, HB					
Density, g/cm ³	8.4	7.5	7.5	7.3	7.3
Delisity, grein					
Tensile Strength, (20°C) / N mm ⁻²					
at 0.004 s ⁻¹ Shear Rate					
at 0.004 S Shear Nate	40	48	58	48	-
Shear Strength N mm ⁻²					
at 0.1mm ⁻¹ , 20°C	23	27	27	23	23
at 0.1mm ⁻¹ , 100°C	14	17	17	16	16
Creep Resistance* N mm ⁻²					
20°C	3.3	13.0	13.7	13.7	8.6
100°C	1.0	5.0	5.0	5.0	2.1

^{*}Complying with ISO 9453:2006

Recommended Conditions of Use

Wave soldering

The recommended operation conditions for wave soldering are the same like normal **ECOLOY**[®] **TC** solders, since the melting point remains!

Purity

Like S-Sn99Cu1 according to DIN EN 61190-1-3 and ISO 9453:2006, but with micro-additive <0.1%.

Supply forms

Solder Wire (solid and flux cored)
Triangular bars
Kg-bars
Ingots with hanging hole

Health and Safety

Before using please read the material safety data sheet carefully and observe the safety precautions described.

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^{**} Complying with ISO 9453:2006 with micro additives <0.05%.